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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Gaynes et al

Ser. No.

10/085,313

Art Unit: 1733

Filed:

February 28, 2002

Examiner: J. T. Haran

Title: METHOD FOR BONDING HEAT

SINKS TO OVERMOLD MATERIAL

Confirmation No. 8607

Docket No. END920010053US1 (IEN-10-5846-C1)

## **AMENDMENT**

Mail Stop Non-Fee Amendment Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Responsive to the Examiner's letter of February 13, 2004, it is respectfully requested that the above entitled application be amended as shown in the attached sheets.